

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT								
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT								
<b>CONVEYING PARTY DATA</b>									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Helmut Fischer</td> <td>04/11/2006</td> </tr> <tr> <td>Jurgen Lindolf</td> <td>04/11/2006</td> </tr> <tr> <td>Michael Bernhard Sommer</td> <td>05/16/2006</td> </tr> </tbody> </table>		Name	Execution Date	Helmut Fischer	04/11/2006	Jurgen Lindolf	04/11/2006	Michael Bernhard Sommer	05/16/2006
Name	Execution Date								
Helmut Fischer	04/11/2006								
Jurgen Lindolf	04/11/2006								
Michael Bernhard Sommer	05/16/2006								
<b>RECEIVING PARTY DATA</b>									
<b>Name:</b>	Infineon Technologies AG								
<b>Street Address:</b>	St.-Martin-Str. 53								
<b>City:</b>	Munich								
<b>State/Country:</b>	GERMANY								
<b>Postal Code:</b>	81669								
<b>PROPERTY NUMBERS Total: 1</b>									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11389540</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11389540				
Property Type	Number								
Application Number:	11389540								
<b>CORRESPONDENCE DATA</b>									
<b>Fax Number:</b>	(301)762-4056								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
<b>Phone:</b>	301/424-3640								
<b>Email:</b>	cag@usiplaw.com, aja@usiplaw.com								
<b>Correspondent Name:</b>	Andrew J. Aldag - ESF, LLC								
<b>Address Line 1:</b>	1901 Research Blvd.								
<b>Address Line 2:</b>	Suite 400								
<b>Address Line 4:</b>	Rockville, MARYLAND 20850								
<b>ATTORNEY DOCKET NUMBER:</b>	3000.0085C								
<b>NAME OF SUBMITTER:</b>	Andrew J. Aldag								

Total Attachments: 3  
 source=exe asg 11389540#page1.tif

**OP \$40.00 11389540**

source=exe asg 11389540#page2.tif

source=exe asg 11389540#page3.tif

**ASSIGNMENT**

For good and valuable consideration, WE, Helmut Fischer, a citizen of Germany, residing at Erich-Stegmann-Weg. 1, 82041 Oberhaching, Germany; Jürgen Lindolf, a citizen of Germany, residing at Terlaner Str. 2, 86316 Friedberg, Germany; and Michael Bernhard Sommer, a citizen of Germany, residing at Am Kreidenbach 20a, 83064 Raubling, Germany, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to **Infineon Technologies AG**, a corporation, organized and existing under the laws of Germany, having its principal place of business at St.-Martin-Str. 53, 81669 Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned, entitled:

**INTEGRATED CIRCUIT WITH ELECTROSTATIC DISCHARGE PROTECTION**

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE: Helmut Fischer DATE: April, 11th, 2006  
Helmut Fischer

SIGNATURE: Jürgen Lindolf DATE: April, 11th, 2006  
Jürgen Lindolf

1191/STA

Serial No. Unknown  
Infineon Ref No. P2003,0636 us n  
OC Ref No. 3000.0085C

**ASSIGNMENT**

For good and valuable consideration, WE, Helmut Fischer, a citizen of Germany, residing at Erich-Stegmann-Weg. 1, 82041 Oberhaching, Germany; Jürgen Lindolf, a citizen of Germany, residing at Terlaner Str. 2, 86316 Friedberg, Germany; and Michael Bernhard Sommer, a citizen of Germany, residing at Am Kreidenbach 20a, 83064 Raubling, Germany, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to **Infineon Technologies AG**, a corporation, organized and existing under the laws of Germany, having its principal place of business at St.-Martin-Str. 53, 81669 Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned, entitled:

**INTEGRATED CIRCUIT WITH ELECTROSTATIC DISCHARGE PROTECTION**

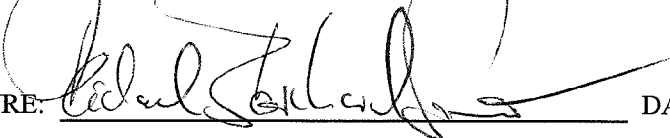
and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

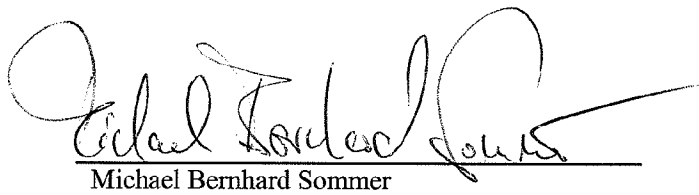
Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

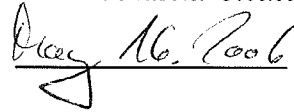
SIGNATURE: \_\_\_\_\_ DATE: \_\_\_\_\_  
Helmut Fischer

SIGNATURE: \_\_\_\_\_ DATE: \_\_\_\_\_  
Jürgen Lindolf

SIGNATURE:  \_\_\_\_\_ DATE: May 16, 2006

  
Michael Bernhard Sommer

Serial No. Unknown  
Infineon Ref No. P2003,0636 us n  
OC Ref No. 3000.0085C

  
May 16, 2006